

Application Data Sheet

Application Information

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Title ::

MANUFACTURING METHOD
OF SEMICONDUCTOR
DEVICE

Attorney Docket Number::

0756-7196

Total Drawing Sheets::

9

Small Entity?::

No

Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Given Name::

Shunpei

Middle Name::

Family Name::

YAMAZAKI

Name Suffix::

City of Residence::

Setagaya

State or Province of Residence::

Tokyo

Country of Residence::

Japan

Street of mailing address::

c/o Semiconductor Energy
Laboratory Co., Ltd., 398,
Hase

City of mailing address::

Atsugi-shi

State or Province of mailing address::	Kanagawa-ken
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	243-0036
Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Given Name::	Mitsuaki
Middle Name::	
Family Name::	OSAME
Name Suffix::	
City of Residence::	Atsugi
State or Province of Residence::	Kanagawa
Country of Residence::	Japan
Street of mailing address::	c/o Semiconductor Energy Laboratory Co., Ltd., 398, Hase
City of mailing address::	Atsugi-shi
State or Province of mailing address::	Kanagawa-ken
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	243-0036

Correspondence Information

Correspondence Customer Number ::	31780
E-Mail address::	erobinson@riplo.com

Representative Information

Representative Customer Number:: 31780

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-276379	09/20/2002	Yes

Assignee Information

Assignee name::	Semiconductor Energy Laboratory Co., Ltd.
Street of mailing address::	398 Hase
City of mailing address::	Atsugi-shi
State or Province of mailing address::	Kangawa-ken
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	243-0036